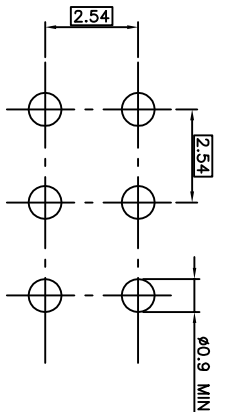
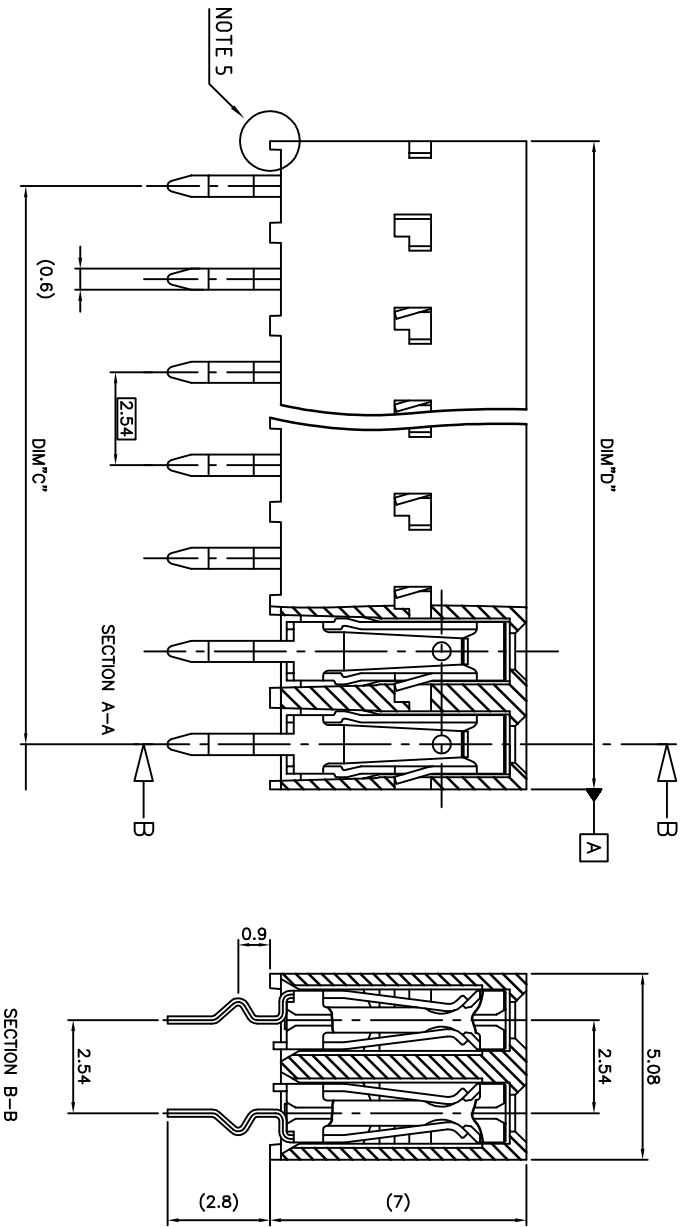


RECOMMENDED HOLE PATTERN



PRODUCT NUMBER	NUMBER OF POS.	DIM"C"	DIM"D"
71998-Y02(H)LF	2 x 02	2.54	5.00
71998-Y03(H)LF	2 x 03	5.08	7.54
71998-Y04(H)LF	2 x 04	7.62	10.08
71998-Y05(H)LF	2 x 05	10.16	12.62
71998-Y06(H)LF	2 x 06	12.70	15.16
71998-Y07(H)LF	2 x 07	15.24	17.70
71998-Y08(H)LF	2 x 08	17.78	20.24
71998-Y09(H)LF	2 x 09	20.32	22.78
71998-Y10(H)LF	2 x 10	22.86	25.32
71998-Y13(H)LF	2 x 13	30.48	32.94

ROHS COMPATIBLE, SEE NOTE 4
 WHEN NEEDED, SUFFIX LETTER "H"
 INDICATES IT'S A HIGH TEMPERATURE PRODUCT
 SEE NOTE 2



71998-4XX(H)LF	5µm Sn	Sn
71998-3XX(H)LF	0.76 µm GOLD	Sn
PLATING CODE	CONTACT AREA	SOLDER TAIL
	PLATING THICKNESS OVER 1.27µm Ni	

NOTES:

- MATERIAL HOUSING: THERMOPLASTIC POLYESTER 30% GLASS FILLED COLOUR BLUE; FLAME RETARDANT PER UL-94 CATEGORY V0
- MATERIAL HOUSING: HIGH TEMPERATURE THERMOPLASTIC 30% GLASS FILLED, COLOUR GREY; FLAME RETARDANT PER UL-94 CATEGORY V0.
- MATERIAL TERMINAL: PHOSPHOR BRONZE EXTRA HARD.
- ROHS COMPATIBLE PRODUCT SPECIFICATIONS
 - a - PLATING:
 - "LF" MEANS THE PRODUCT IS LEAD-FREE, 2µm MINIMUM MATTE TIN OVER 1.27µm MINIMUM NICKEL UNDERPLATE.
 - b - MANUFACTURING PROCESS COMPATIBILITY
 - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
 - c - LABELING:
 - MEETS PACKAGING SPECS AS PER GS-14-920
 - d - LEGAL STATEMENT: SEE GS-47-0004
- END STAND-OFFS FOR 2x2 UP TO 2x5 POS
 NO END STAND-OFFS FOR 2x6 UP TO 2x50 POS

mat'l. code	surface	tolerance	projection	product family
SEE NOTES	ISO 5002	ISO 456, 50 MIL	Ø	DX VCC DR
LT#	ECO no	DATE	tolerance unless otherwise specified	title
J F11-0043	J00	12/02/22	mm	KINKED
K B-19123	LMU	14/10/20	mm	LEGS
E F06-0133	DLE	06/02/27	mm	
F F06-0204	DLE	06/06/20	mm	
G F07-0198	DLE	07/05/31	mm	
H F07-0271	LMU	07/12/06	mm	
revision	P NZ	04/11/17		
sheet				
index				



71998
 CUSTOMER
 Drawing